

TRADEMARK ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	Termination and Release of Security Interest in Trademark Rights

CONVEYING PARTY DATA

Name	Formerly	Execution Date	Entity Type
Highpoint Capital Funding, LLC		04/17/2008	LIMITED LIABILITY COMPANY: DELAWARE

RECEIVING PARTY DATA

Name:	Solidscape, Inc.
Street Address:	316 Daniel Webster Highway
City:	Merrimack
State/Country:	NEW HAMPSHIRE
Postal Code:	03054
Entity Type:	CORPORATION: DELAWARE

PROPERTY NUMBERS Total: 12

Property Type	Number	Word Mark
Registration Number:	2715001	SOLIDSCAPE
Registration Number:	2774050	T66
Registration Number:	2776667	T612
Registration Number:	2621366	PATTERNMASTER
Serial Number:	78608404	T76
Serial Number:	78608406	I6X
Serial Number:	78608409	I12X
Serial Number:	78773821	RMS-1
Serial Number:	78736165	RMS-2
Serial Number:	78736185	RMS-4
Serial Number:	78871782	T75
Serial Number:	78871779	D76

CORRESPONDENCE DATA

OP \$315.00 2715001

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NAME OF SUBMITTER:	Shannon L. McGuire
Signature:	/SLMcGuire/
Date:	04/18/2008

Total Attachments: 3
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**TERMINATION AND RELEASE OF
SECURITY INTEREST IN TRADEMARK RIGHTS**

TERMINATION AND RELEASE OF SECURITY INTEREST IN TRADEMARK RIGHTS (this "Termination and Release"), dated as of April 17, 2008 by **HIGHPOINT CAPITAL FUNDING, LLC** ("Lender"), a Delaware limited liability company with a place of business at One Boston Place, Boston, Massachusetts 02108, in connection with the grant of security interests in certain trademarks by **SOLIDSCAPE, INC.** (the "Assignor"), a Delaware corporation with a place of business at 316 Daniel Webster Highway, Merrimack, NH 03054 in favor of HighPoint Capital Funding, LLC.

WITNESSETH:

WHEREAS, the Assignor entered into an agreement with the Lender which was recorded in the Trademark Division of the United States Patent and Trademark Office on June 14, 2006 at Reel 003327, Frame 0369 for the purpose of providing certain trademarks as collateral security for the payment and performance of certain obligations of the Assignor to the Lender; and

WHEREAS, the Lender now desires to terminate and release the entirety of its security interest in the Trademark Collateral (as defined below);

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the Lender hereby agrees as follows:


1. Definitions. The term "***Trademark Collateral***", as used herein, shall mean all of the Assignor's right, title and interest of every kind and nature as of the date hereof in the Assignor's trademarks (including, without limitation, those items listed on Schedule A thereto).

2. Release of Security Interest. The Lender hereby terminates, releases and discharges its security interest in the Trademark Collateral without representation, warranty or recourse of any kind or nature.

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IN WITNESS WHEREOF, the undersigned has executed this Termination and Release by its duly authorized officer as of the date first above written.

HIGHPOINT CAPITAL FUNDING, LLC

By: 
Name: Jake Gormy
Title: Director

SCHEDULE A

TRADEMARKS AND TRADEMARK REGISTRATIONS

<u>Trademark</u> or <u>Service Mark</u>	<u>Registrations --</u> United States Patent and Trademark Office <u>Registration No.</u>	<u>Registration Date</u>
Solidscape	2,715,001	05/13/2003
T66 Small format model making device	2,774,050	10/14/2003
T612 Large format model making device	2,776,667	10/21/2003
PATTERNMASTER	2,621,366	09/17/2002
<u>Trademark</u> or <u>Service Mark</u>	<u>Pending Applications --</u> United States Patent and Trademark Office <u>Serial No.</u>	<u>Filing Date</u>
T76 Next generation, mid market model making system	78608404	04/14/2005
i6X Future generation, small format model making device	78608406	04/14/2005
i12x Future generation, low-end model making device	78608409	04/14/2005
RMS-1 Single jet source industrial model making device	78773821	12/15/2005
	78736165	10/19/2005
RMS-2 Duel jet source industrial model making device		
RMS-4 Quad jet source industrial model making device	78736185	10/19/2005
T75	78-871782	4/28/2006
D76	78-871779	4/28/2006